



60V N-Channel Trench Power MOSFET

General Description

The SJD60N043 uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 10V. This device is suitable for use as a wide variety of applications.

Features

- Low Gate Charge
- 100% UIS Tested, 100% DVDS Tested
- High Power and current handling capability
- Lead free product is acquired

Application

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification

Key Performance Parameters

Parameter	Value	Unit
V_{DS}	60	V
$R_{DS(ON_TYP)}$	4.8	m Ω
I_D	90	A
Q_G	76	nC



Package Marking and Ordering Information

Device/Ordering Code	Marking	Package	Packing	Reel Size	Tape width	Quantity
SJD60N043	SJD60N043	TO-252	Tape	\	\	2500 Pcs

Table 1. Absolute Maximum Ratings ($T_C=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Limit	Unit
V_{DS}	Drain-Source Voltage ($V_{GS}=0V$)	60	V
V_{GS}	Gate-Source Voltage ($V_{DS}=0V$)	± 20	V
I_D	Drain Current-Continuous($T_C=25^\circ\text{C}$)	90	A
	Drain Current-Continuous($T_C=100^\circ\text{C}$)	56	A
I_{DM} (pluse)	Drain Current-Continuous@ Current-Pulsed (Note 1)	360	A
P_D	Maximum Power Dissipation($T_C=25^\circ\text{C}$)	94	W
	Maximum Power Dissipation($T_C=100^\circ\text{C}$)	38	W
E_{AS}	Avalanche energy (Note 2)	400	mJ
T_J, T_{STG}	Operating Junction and Storage Temperature Range	-55 To 150	$^\circ\text{C}$

Table 2. Thermal Characteristic

Symbol	Parameter	Typ	Max	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case		1.33	$^\circ\text{C/W}$



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Table 3. Electrical Characteristics ($T_J=25^{\circ}\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
On/Off States						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	60			V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS}=60V, V_{GS}=0V, T_J=25^{\circ}\text{C}$			1	μA
		$V_{DS}=60V, V_{GS}=0V, T_J=125^{\circ}\text{C}$			100	μA
I_{GSS}	Gate-Body Leakage Current	$V_{GS}=\pm 20V, V_{DS}=0V$			± 100	nA
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu A$	2		4	V
g_{FS}	Forward Transconductance	$V_{DS}=10V, I_D=20A$		36.5		S
$R_{DS(ON)}$	Drain-Source On-State Resistance	$V_{GS}=10V, I_D=20A, T_J=25^{\circ}\text{C}$		4.8	5.5	m Ω
Dynamic Characteristics						
C_{iss}	Input Capacitance	$V_{DS}=30V, V_{GS}=0V, f=1.0\text{MHz}$		4762		pF
C_{oss}	Output Capacitance			265		pF
C_{rss}	Reverse Transfer Capacitance			230		pF
R_g	Gate resistance	$V_{GS}=0V, V_{DS}=0V, f=1.0\text{MHz}$		0.86		Ω
Switching Parameters						
$t_{d(on)}$	Turn-on Delay Time	$V_{GS}=10V, V_{DS}=30V, R_L=1.5\Omega, R_{GEN}=3\Omega$		20		nS
t_r	Turn-on Rise Time			90		nS
$t_{d(off)}$	Turn-Off Delay Time			37		nS
t_f	Turn-Off Fall Time			85		nS
Q_g	Total Gate Charge	$V_{GS}=10V, V_{DS}=30V, I_D=20A$		76		nC
Q_{gs}	Gate-Source Charge			21		nC
Q_{gd}	Gate-Drain Charge			24		nC
Source-Drain Diode Characteristics						
I_{SD}	Source-Drain Current (Body Diode)				90	A
V_{SD}	Forward on Voltage (Note 3)	$V_{GS}=0V, I_S=20A$			1.2	V
t_{rr}	Reverse Recovery Time	$I_F=20A, dI/dt=100A/\mu s$		25		ns
Q_{rr}	Reverse Recovery Charge	$I_F=20A, dI/dt=100A/\mu s$		30		nC

Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature.

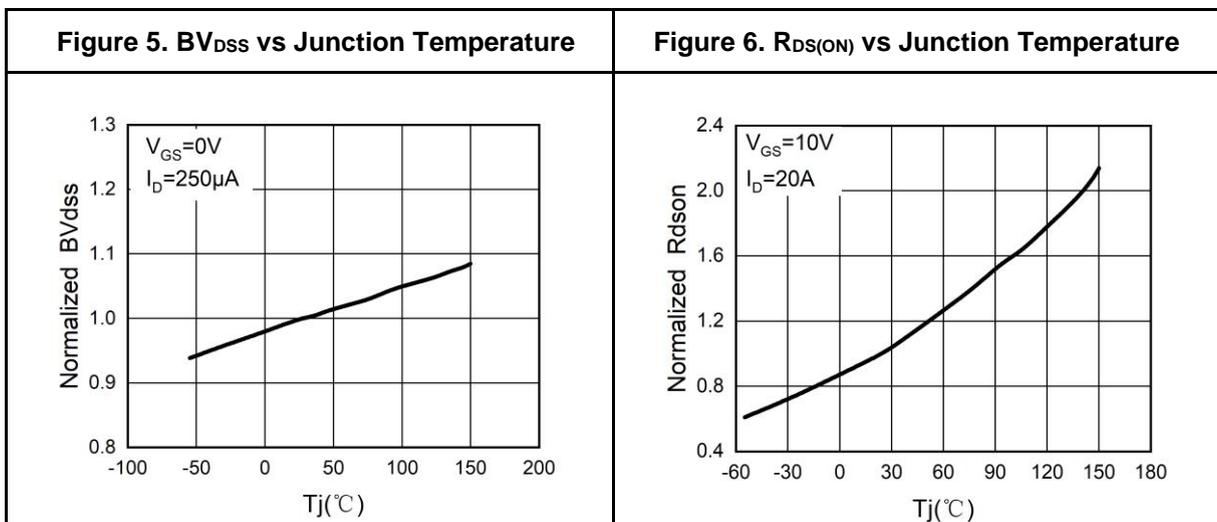
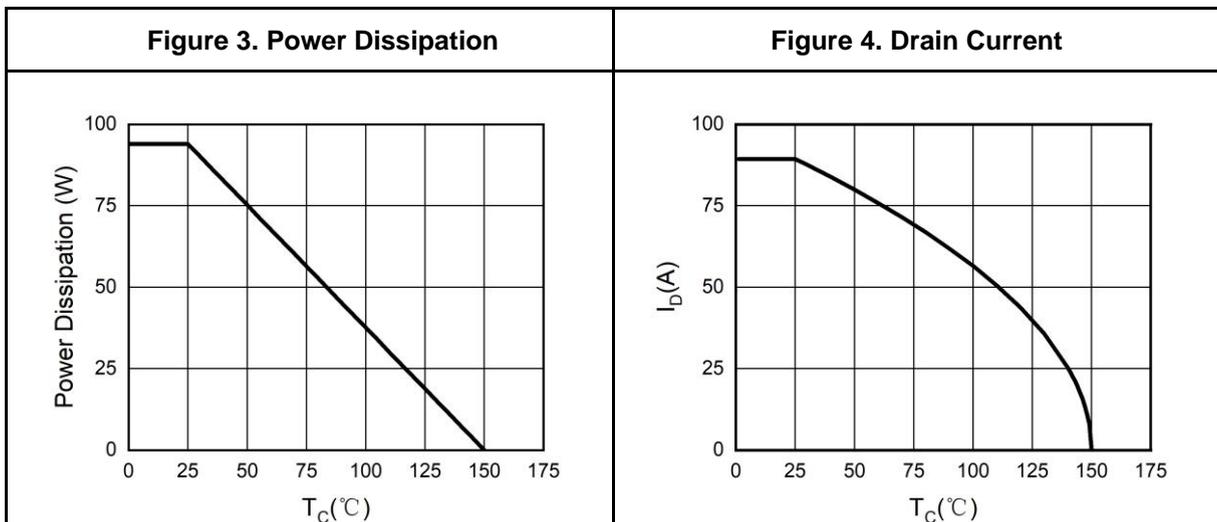
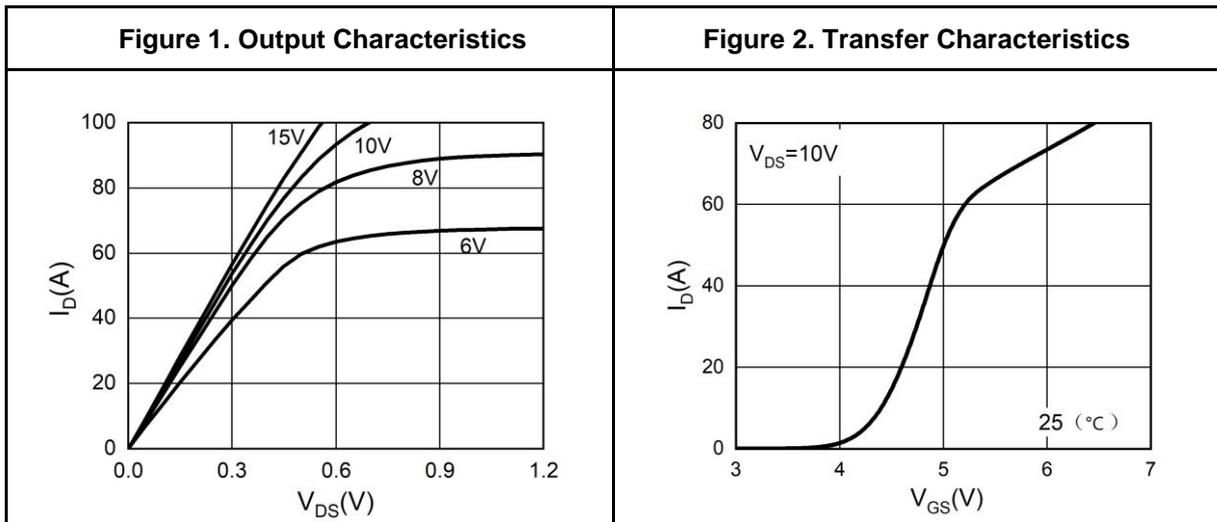
Notes 2. E_{AS} condition: $T_J=25^{\circ}\text{C}, V_{DD}=40V, V_G=10V, R_g=25\Omega, L=0.5\text{mH}$.

Notes 3.Repetitive Rating: Pulse width limited by maximum junction temperature.



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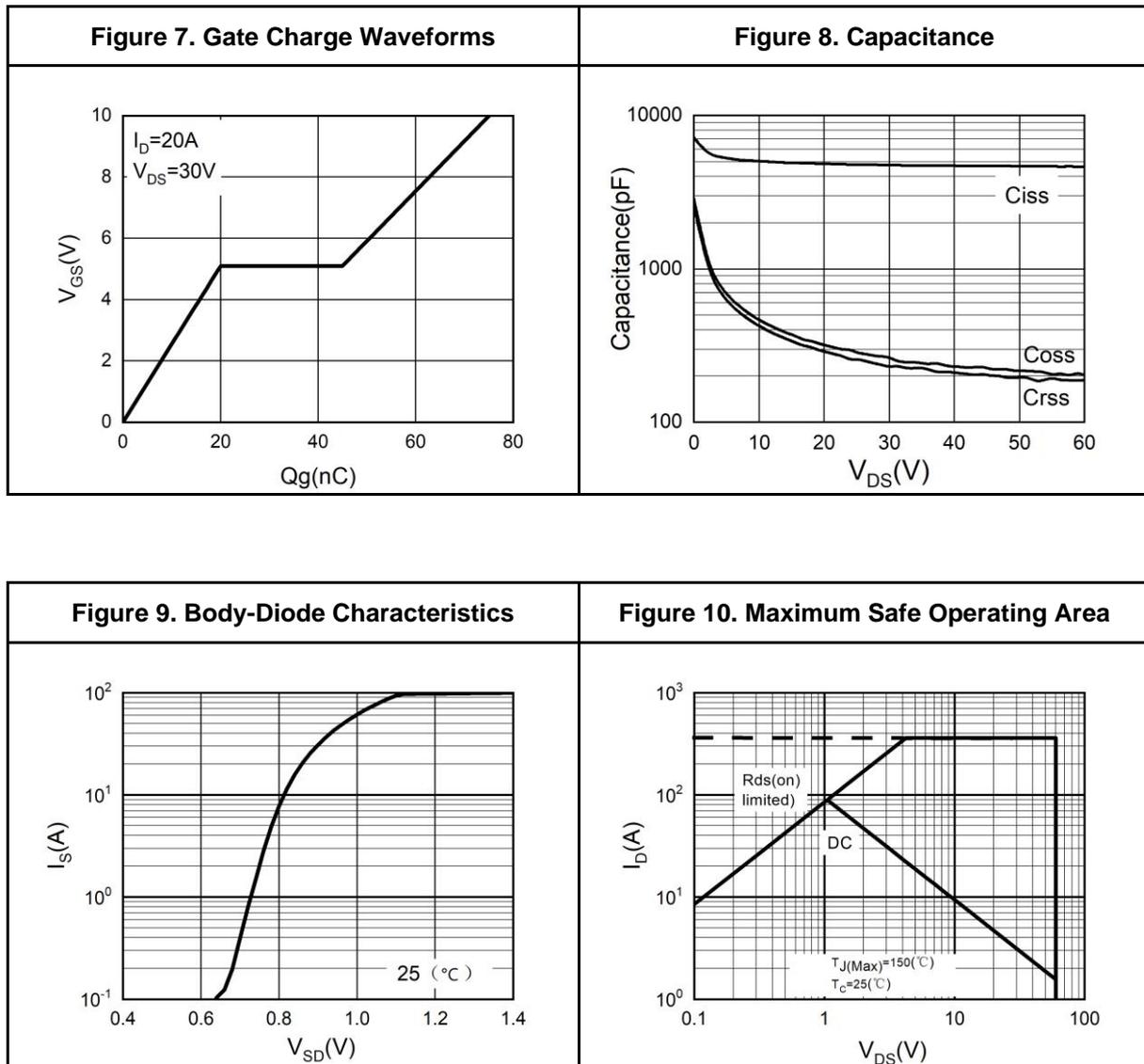
Typical Electrical And Thermal Characteristics (Curves)





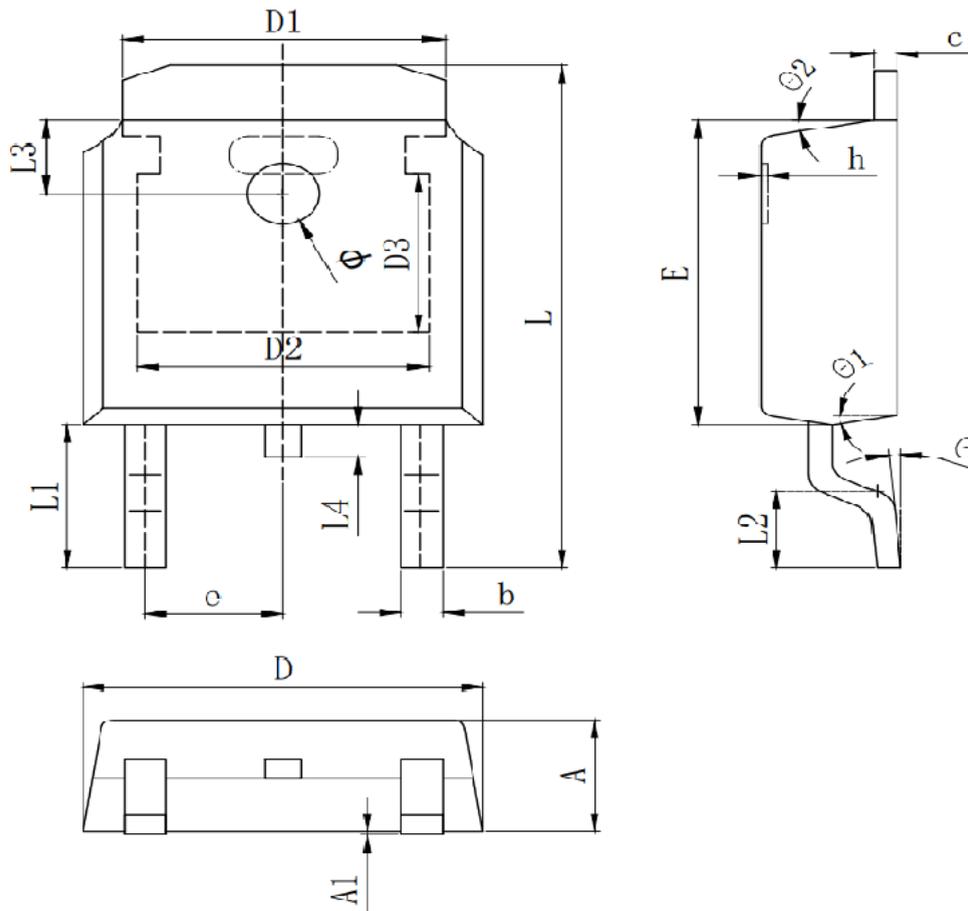
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Typical Electrical And Thermal Characteristics (Curves)





TO-252 Package Information



Symbol	Dimensions In Millimeters		
	Min.	Typ.	Max.
A	2.200	2.300	2.400
A1	0.000		0.127
b	0.640	0.690	0.740
c(电镀后)	0.460	0.520	0.580
D	6.500	6.600	6.700
D1	5.334 REF		
D2	4.826 REF		
D3	3.166 REF		
E	6.000	6.100	6.200
e	2.286 TYP		
h	0.000	0.100	0.200
L	9.900	10.100	10.300
L1	2.888 REF		
L2	1.400	1.550	1.700
L3	1.600 REF		
L4	0.600	0.800	1.000
ϕ	1.100	1.200	1.300
θ	0°		8°
θ_1	9° TYP		
θ_2	9° TYP		



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This product described in this document can not be used in life support devices or systems, aircraft's control systems, and other applications whose failure can be reasonably expected to result in serious physical and/or material damage, apart from that when an application agreement is signed between customer and Wuxi Shangjia Semiconductor

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